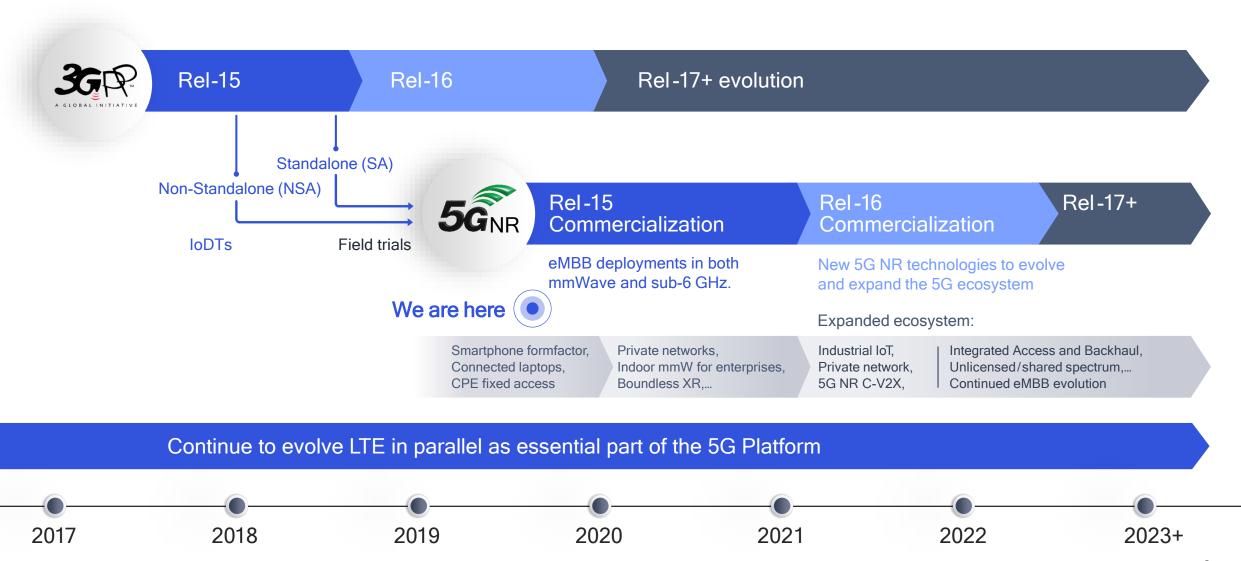


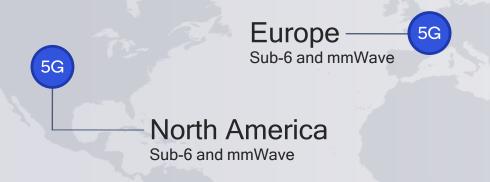


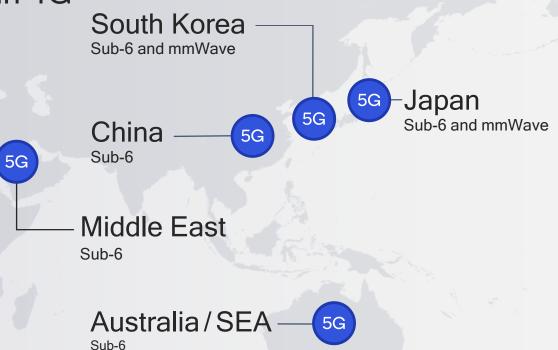
Driving the 5G roadmap and ecosystem expansion



2019 is the year of 5G

Global commercialization moving faster than 4G









4 Operators launched

3 OEMs launched



20+ Operators launched

20+ OEMs launched





5G will expand the mobile ecosystem to new industries

Powering the digital economy

>\$12 Trillion

In goods and services by 2035°



Transforming the wireless edge

Delivering new and enhanced services with 5G + AI



Industrial IoT with URLLC



Smarter transportation with C-V2X

Cloud

Big data, Al training, less delay sensitive content, storage,...

Augmented by edge cloud

Compute/processing, content, control, storage,.. closer to user¹

Driving the best possible on-device capabilities

Sensing, processing, security, intelligence



Immersive boundless XR



Instant cloud access, gaming



On-device virtual assistant



Latency could be

over 100s ms today





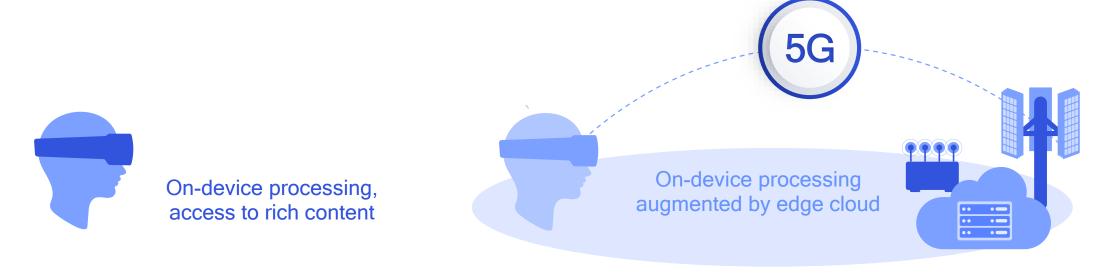
Latency as low as 1 ms

Cooperation between operators, infra vendors, OEMs, content providers, cloud providers,...

?

Future services unknown today

Boundless XR – the best possible XR anywhere



Premium XR anywhere

Efficient on-device processing to deliver immersive XR

Utilize connectivity for less time-sensitive content and downloads

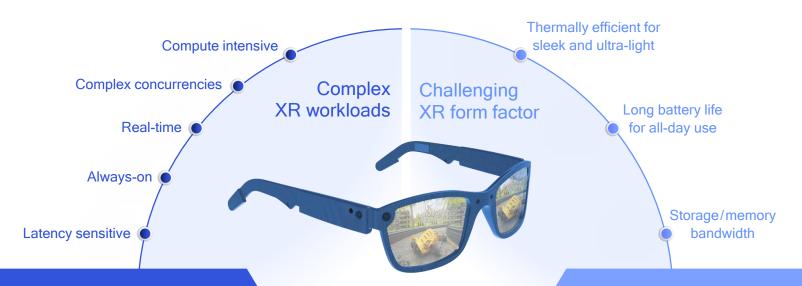
We are doing this today

Photorealistic graphics and visuals

Enhanced experience where possible with new split-rendering architecture

On-device processing augmented by compute located at cloud edge over 5G connectivity

A new era in distributed processing



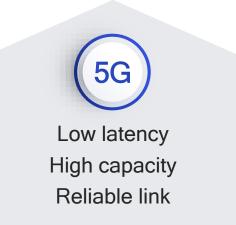
Essential on-device processing

Split rendering

Augment by edge cloud processing

Optimized under strict power, thermal, size constraints

Premium experiences today that continuously improve



Significant higher power envelope—beyond PC class

Augment on-device rendering with edge cloud rendering

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